

N-Channel Enhancement Mode Field Effect Transistor

General Description

The CMN2042M combines advanced trench MOSFET technology with a low resistance package to provide extremely low RDS(ON). This device is ideal for boost converters and synchronous rectifiers for consumer, telecom, industrial power supplies and LED backlighting.

Features

- RDS(ON)<1.2Ω @ VGS=10V
- SOT-23-3L Package

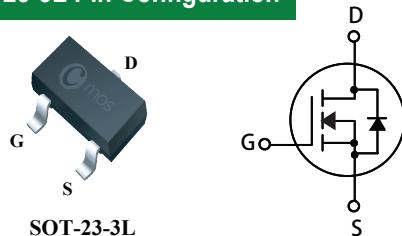
Product Summary

BVDSS	RDS(ON)	ID
200V	1.2Ω	1.2A

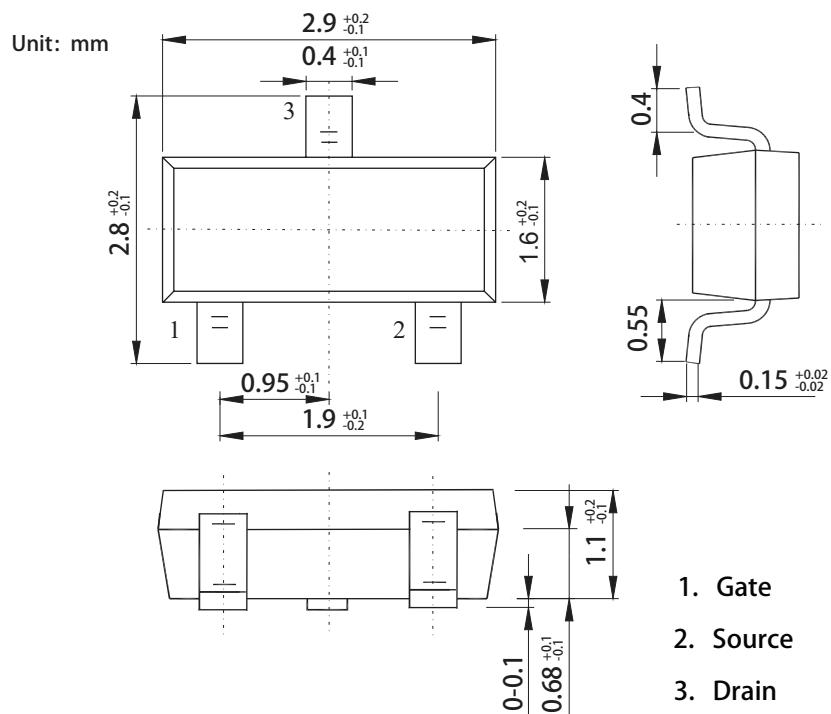
Applications

- DC-DC converters
- Load Switch
- System Switch

SOT-23-3L Pin Configuration



Type	Package	Marking
CMN2042M	SOT-23-3L	2042M



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Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	200	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_A = 25^\circ C$	Continuous Drain Current	1.2	A
I_{DM}	Pulsed Drain Current	3.6	A
$P_D @ T_A = 25^\circ C$	Total Power Dissipation	1.3	W
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient	---	50	$^\circ C/W$

Electrical Characteristics ($T_J=25^\circ C$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V$, $I_D=250\mu A$	200	---	---	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V$, $I_D=1A$	---	---	1.2	Ω
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250\mu A$	1.0	---	3.0	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=250V$, $V_{GS}=0V$	---	---	1	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V$, $V_{DS}=0V$	---	---	± 100	nA
g_{fs}	Forward Transconductance	$V_{DS}=5V$, $I_D=1A$	---	4	---	S
Q_g	Total Gate Charge	$I_D=4.5A$	---	7.0	---	nC
Q_{gs}	Gate-Source Charge	$V_{DS}=160V$	---	2.0	---	
Q_{gd}	Gate-Drain Charge	$V_{GS}=10V$	---	2.5	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=100V$	---	8	---	ns
T_r	Rise Time	$R_G=25\Omega$	---	56	---	
$T_{d(off)}$	Turn-Off Delay Time	$I_D=4.5A$	---	10	---	
T_f	Fall Time		---	26	---	
C_{iss}	Input Capacitance		---	420	---	pF
C_{oss}	Output Capacitance	$V_{DS}=25V$, $V_{GS}=0V$, $f=1MHz$	---	40	---	
C_{rss}	Reverse Transfer Capacitance		---	6	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_{SD}	Diode Forward Voltage	$V_{GS}=0V$, $I_S=2A$	---	---	1	V

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